

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**22240 U.S.P.T.O.
10/686568

Applicant: Hirokazu HONDA

Title: METHOD OF MANUFACTURING A FLIP-CHIP
SEMICONDUCTOR DEVICE WITH A STRESS-ABSORBING
LAYER MADE OF THERMOSETTING RESIN

Prior Appl. No.: 09/704,521

Prior Appl.
Filing Date: 11/03/2000

Examiner: Unassigned

Art Unit: 2824

CONTINUING PATENT APPLICATION
TRANSMITTAL LETTERMail Stop PATENT APPLICATION
Commissioner for Patents
PO Box 1450
Alexandria, Virginia 22313-1450

Sir:

Transmitted herewith for filing under 37 C.F.R. § 1.53(b) is a:

[] Continuation [X] Division [] Continuation-In-Part (CIP)

of the above-identified copending prior application in which no patenting, abandonment, or termination of proceedings has occurred. Priority to the above-identified prior application is hereby claimed under 35 U.S.C. § 120 for this continuing application. The entire disclosure of the above-identified prior application is considered as being part of the disclosure of the accompanying continuing application and is hereby incorporated by reference therein.

Enclosed are:

[X] Application Data Sheet (37 CFR 1.76) (2 pages).

[X] Specification, Claim(s), and Abstract (25 pages).

[X] Formal drawings (37 sheets, Figures 1A, 1B, 1C, 2A, 2B, 2C, 2D, 2E, 2F, 2G, 2H, 2I, 2J, 3, 4, 5A, 5B, 5C, 5D, 5E, 5F, 6A, 6B, 6C, 6D, 6E, 6F, 6G, 6H, 6I, 6J, 6K, 6L, 6M, 6N, 7, 8A, 8B, 8C, 8D, 8E, 8F, 8G, 8H, 8I, 8J, 8K, 8L, 8M, 8N, 9A, 9B, 9C, 10A, 10B, 10C, 11A, 11B, 11C, 11D, 11E, 12A, 12B, 12C,

12D, 12E, 13A, 13B, 13C, 13D, 13E, 13F, 13G, 13H, 13I, 13J, 13K, 13L, 13M, 14A, 14B, 14C, 14D, 14E, 14F, 14G, 14H, 14I, 14J, 14K, 14L, 14M, 14N, 14O, 14P, 14Q).

Copy of Declaration and Power of Attorney (2 pages).

Information Disclosure Statement (2 pages).

Form PTO-SB08 (2 pages).

The filing fee is calculated below:

	Claims as Filed	Included in Basic Fee	Extra Claims	Rate	Fee Totals
Basic Fee				\$770.00	\$770.00
Total Claims:	1	- 20	= 0	$\times \$18.00$	\$0.00
Independent Claims:	1	- 3	= 0	$\times \$86.00$	\$0.00
If any Multiple Dependent Claim(s) present:				$+ \$290.00$	\$0.00
				SUBTOTAL:	\$770.00
<input type="checkbox"/> Small Entity Fees Apply (subtract 1/2 of above):					\$0.00
				TOTAL FILING FEE:	\$770.00

A check in the amount of \$770.00 to cover the filing fee is enclosed.

The required filing fees are not enclosed but will be submitted in response to the Notice to File Missing Parts of Application.

The Commissioner is hereby authorized to charge any additional fees which may be required regarding this application under 37 C.F.R. §§ 1.16-1.17, or credit any overpayment, to Deposit Account No. 19-0741. Should no proper payment be enclosed herewith, as by a check being in the wrong amount, unsigned, post-dated, otherwise improper or informal or even entirely missing, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 19-0741.

The claim presently pending in this divisional application corresponds to claim 45 of the parent application placed in independent form, whereby that claim was not elected in the prosecution of the parent application.

Please direct all correspondence to the undersigned attorney or agent at the address indicated below.

Respectfully submitted,

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Date: October 17, 2003

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